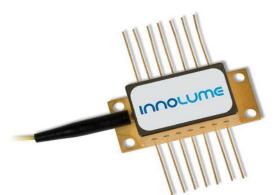
# FBG-119X-PM-500

Fiber Bragg Grating wavelength locked High Power Laser Diode



#### **Features:**

- Kink-free operation up to 500mW
- Any wavelengths available in the range 1180-1195nm
- · Individual burn-in and thermal cycling screening
- · Proprietary mirror coating technology enabling high reliability
- · Built-in monitor photodiode (optional)
- 900um loose tube on fiber (optional)

#### **Applications:**

· Raman amplifier pumping

Recommended Operating Conditions				
@ CW, the case is mounted on room temperature heatsink				
Parameter	Min.	Тур.	Max.	Unit
Chip Temperature (Top)	20	25	40	°C
Forward Current		1300	1500	mA
Output Power*	25		500	mW

<sup>\*</sup> kink-free over the entire range

Characteristics				
@ CW, Top*, 1300mA				
Parameter	Min.	Тур.	Max.	Unit
Output Power @ 1500mA	500			mW
Forward Voltage		1.7	2	V
Threshold Current		150	250	mA
Range of Available Wavelengths	1180		1195	nm
Mean Wavelength Tolerance**			±2	nm
Bandwidth (FWHM)**	0.1	0.3	1.2	nm
Wavelength shift with FBG temperature		0.01		nm/°C
Polarisation Extinction Ratio (PER)	15	18		dB
Polarisation		TE		

<sup>\* -</sup> specific chip temperature mentioned in individual test report

<sup>\*\* -</sup> custom wavelength tolerance and bandwidth available on request

Absolute Maximum Ratings			
Parameter	Min	Max	Unit
Forward Current		1600	mA
Reverse Voltage		2	V
TEC Current		3	Α
TEC Voltage		4	V
Chip Operating Temperature	5	50	°C
Case Operating Temperature	0	70	°C
Storage Temperature	-40	85	°C
FBG Operating Temperature	-40	85	°C
Fiber Band Radius	3		cm

**Fiber specification** 

Numerical Aperture (Typical)

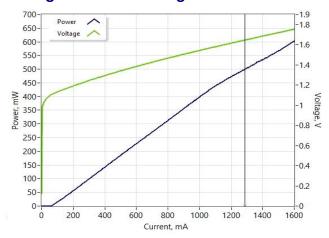
**Parameters** 

Fiber Type

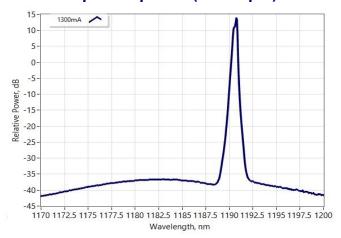


## Typical Performance (for reference only)

#### **Light Current Voltage Characteristics**



#### Optical Spectra (res. 50pm)



**Value** 

HI1060

0.14

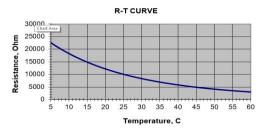
**Value** 

PM980

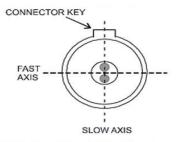
0.12

Unit

Thermistor specification			
Parameters	Value	Unit	
Туре	NTC		
Resistance @ 25°C	10±0.1	kOhm	
Beta 0-50°C	3430±1%	K	



Cut-off Wavelength	920±50	900±70	nm
Mode-Field Diameter	6.2±0.3 @1060nm	6.6±0.3 @1060nm	μm
Cladding Diameter	125±1	125±1	μm
Coating Diameter	245±15	245±15	μm
Loose Tube Diameter (optional)	900	900	μm
Connector	FC/APC	FC/APC	
Key	narrow	narrow	



The output light is polarized along the slow axis of PM fiber.

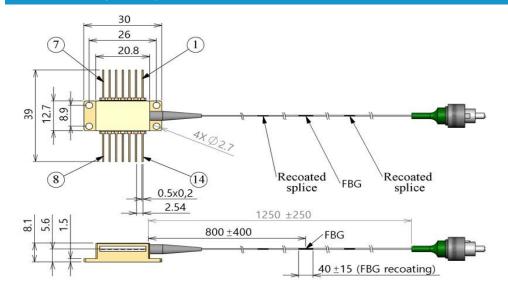
#### **Part-number Identification**

FBG-1180-PM-500 -> 500mW output power at 1180nm mean wavelength, PM980 fiber FBG-1195-HI-500-PD-LT -> 500mW output power at 1195nm mean wavelength, HI1060 fiber, with built-in monitor photodiode and fiber loose tube

NOTE: Innolume product specifications are subject to change without notice



### **Dimensions (in mm)**



#### Pin identification:

- 1. TEC "+"
- 2. Thermistor
- 3. Monitor PD anode ("-")
- 4. Monitor PD cathode ("+")
- 5. Thermistor
- 6. -
- 7. -8. -
- 9. -
- 10. LD anode ("+")
  11. LD cathode ("-")
- 12. -
- 13. Case
- 14. TEC "-"

### Safety and Operating Instructions

The light emitted from this device is invisible and can be harmful to the human eye. Avoid looking directly into the fiber connector when the device is in operation. Proper laser safety eyewear must be worn during operation with open connector. Absolute Maximum Ratings may be applied to the device for short period of time only. Exposure to maximum ratings for extended period of time or exposure to more than one maximum rating may cause damage or affect the reliability of the device. Operating the device outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum forward current cannot be exceeded.

A proper heatsink for the device on thermal radiator is required. The device must be mounted on radiator with 4 screws (bolt down in X-style fashion with initial torque set to 0.075Nm and final X-style bolt down at 0.15Nm) or with clamps. The deviation from flatness of radiator surface must be less than 0.05mm. It's recommended using of Indium foil or thermal conductive and soft material between bottom of the case and heatsink for thermal interface. It's undesirable to use thermal grease for this. Avoid back reflection to the device. It may give impact on the device performance in aspects of spectrum and power stability. It also may cause fatal facet damage. Using of optical isolators is highly recommended to block back reflection. Do not pull the fiber. Do not bend a fiber with a radius smaller than 3 cm. Fiber tip should always be protected from any contamination or damage during the process of installation. After removing the dust-preventing cap covered at fiber tip, carefully clean fiber tip by wiping through one direction using optical lens cleaning paper or cotton swab dabbed with Iso-Propanol or Ethyl alcohol. Operate the device with clean fiber connector only.

Electrostatic discharge is the primary cause of unexpected product failure. Take extreme precaution to prevent ESD. During device installation, ESD protection has to be maintained - use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling the product.











# **Specification**

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Revision	history	
Rev	Date	Description
01	10 Mar 2023	Initial issue of the document